

CMOS CAMERA MODULES

your BEST camera module partner

JAL-PC5640-V2

OmniVision OV5640 USB Interfaccia Messa a fuoco automatica 5MP Modulo telecamera



Modulo telecamera n.	JAL-PC5640-V2	
Sensore d'immagine	OV5640	Output Format: MJPG, YVY2
EFL	3.29 mm	5 FPS 2592 x 1944 (Full Frame)
F.NO	2.8	15 FPS 1920 x 1080 (Full HD)
Pixel	2592 x 1944	15 FPS 1280 x 720 (HD 720P)
Vista ad angolo	68.7°	Supporting OS
Tipo di lente	1/4 pollice	Windows 7, 8.1, 10,Vista
Dimensioni dell'obiettivo	8.50 x 8.50 x 5.55 mm	Windows XP SP2 under UVC
Dimensione del modulo	60.00 x 8.50 mm	Linux Kernel V2.6.2.1 or later
Tipo di modulo	Messa a fuoco automatica	MAC OS 10.4 or later
Interfaccia	USB 2.0	Operating Voltage: 5V +/- 5%
Modello obiettivo IMT	IMT-2A6E004-6	Compliant with UVC Version 1.0



www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

All rights reserved @ Kai Lap Technologies Group Ltd. Specifications subject to change without notice.

OV5640 5-megapixel product brief

1/4-inch, 5-Megapixel SOC Image Sensor Optimized for High-Volume Mobile Markets

The OV5640 delivers a complete 5-megapixel camera solution on a single chip, aimed at offering cost efficiencies that serve the highvolume autofocus (AF) camera phone market. The system-on-achip (SOC) sensor features OmniVision's 1.4 micron OmniBSI™ backside illumination architecture to deliver excellent pixel performance and best-in-class low-light sensitivity, while enabling ultra compact camera module designs of 8.5 mm x 8.5 mm with <6 mm z-height. The OV5640 provides the full functionality of a complete camera, including anti-shake technology, AF control, and MIPI while being easier to tune then two-chip solutions, making it an ideal choice in terms of cost, time-to-market and ease of platform integration.

available in

a lead-free

package

The OV5640 enables 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps with complete user control over formatting and output data transfer. The 720p/60 HD video is captured in full field of view (FOV) with 2 x 2 binning, which doubles the sensitivity and improves the signal-to-noise ratio (SNR). Additionally, a unique post-binning re-sampling filter function removes zigzag artifacts around slant edges and minimizes spatial artifacts to deliver even sharper, crisper color images. To further improve camera performance and user experience, the OV5640 features an internal anti-shake engine for image stabilization, and it supports Scalado[™] tagging for faster image preview and zoom.

The OV5640 offers a digital video port (DVP) parallel interface and a high-speed dual lane MIPI interface, supporting multiple output formats. An integrated JPEG compression engine simplifies data transfer for bandwidth-limited interfaces. The sensor's automatic image control functions include automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), 50/60 Hz automatic luminance detection, and automatic black level calibration (ABLC). The OV5640 delivers programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning. It also offers color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling to improve image quality.

Find out more at www.ovt.com.



Applications

- Mobile Phones
- Digital Still and Video Cameras

Product Features

- 1.4 μm x 1.4 μm pixel with OmniBSI technology for high performance (high sensitivity, low crosstalk, low noise, improved quantum efficiency)
- optical size of 1/4"
- automatic image control functions: -automatic exposure control (AEC) - automatic white balance (AWB) - automatic band filter (ABF) -automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/ weight control, mirror and flip, cropping, windowing, and panning
- image quality controls: color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective
 support for black sun cancellation pixel canceling, and noise canceling
- support for output formats: RAW RGB, RGB565/555/444, CCIR656, YUV422/420, YCbCr422, and compression
- support for LED and flash strobe mode
- support for internal and external frame synchronization for frame exposure mode
- support horizontal binning and vertical sub-sampling

 support horizontal binning and vertical sub-sampling

Entertainment

- post binning resampling filter to minimize spatial/aliasing artifacts on 2x2 binned image
- embedded JPEG compression
- support for anti-shake

.

- automatic 50/60 Hz luminance detection 🔳 digital video port (DVP) parallel output interface and dual lane MIPI output interface
 - embedded 1.5V regulator for core power
 - programmable I/O drive capability, I/O tri-state configurability

 - embedded arbitrary scalar supporting any size from 5 MP and below
 - auto focus control (AFC) with

 - 8.5 x 8.5 x <6mm with both CSP and RW packaging
- embedded AF VCM driver embedded microcontroller lens size: 1/4" suitable for module size of lens chief ray angle: 24°
- input clock frequency: 6 27 MHz shutter: rolling shutter / frame exposure

OV05640-A71A

power supply:

core: 1.5 V ±5%

- I/0: 1.8 V / 2.8 V

power requirements:

active: 140 mA

- standby: 2<mark>0</mark> μA

temperature

output

(color, lead-free, 71-pin CSP3)

■ active array size: 2592 x 1944

(with embedded 1.5 V regulator) analog: 2.6 - 3.0 V (2.8 V typical)

temperature range:
 operating: -30°C to 70°C junction temperature

stable image: 0°C to 50°C junction

output formats: 8/10-bit RAW RGB

Product Specifications

maximum image transfer rate: QSXGA (2592x1944): 15 fps - 1080p: 30 fps

(color, chip probing, 200 µm backgrinding, reconstructed wafer).

- 1280 x 960: 45 fps

OV05640-G04A

- 720p: 60 fps VGA (640x480): 90 fps
- -QVGÀ (320x240): 120 fps
- sensitivity: 600 mV/lux-sec maximum exposure interval:
- 1964 x t_{ROW} max S/N ratio: 36 dB
- dynamic range: 68 dB @ 8x gain
- pixel size: 1.4 μm x 1.4 μm
- dark current: 8 mV/sec @ 60°C junction temperature
- image area: 3673.6 µm x 2738.4 µm
- **package dimensions: CSP3:** 5985 µm x 5835 µm **COB:** 6000 µm x 5850 µm

Functional Block Diagram





Version 1.2, February, 2011

